HEWLETT PACKARD

14.2 mm (0.56 inch) Seven Segment Displays

Technical Data

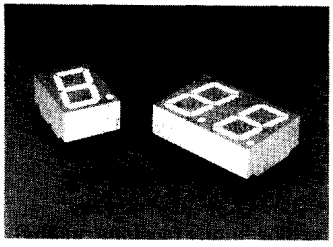
HDSP-530X Series
HDSP-532X Series
HDSP-550X Series
HDSP-552X Series
HDSP-560X Series
HDSP-562X Series
HDSP-570X Series
HDSP-572X Series
HDSP-H15X Series

Features

- **Industry Standard Size**
- **Industry Standard Pinout**
  15.24 mm (0.6 in.) DIP Leads on 2.54 mm (0.1 in.) Centers
- **Choice of Colors**
  Red, AlGaAs Red, High Efficiency Red, Yellow, Green
- **Excellent Appearance**
  Evenly Lighted Segments
  Mitered Corners on Segments
  Gray Package Gives Optimum Contrast
  ±50° Viewing Angle
- **Design Flexibility**
  Common Anode or Common Cathode
  Single and Dual Digits
  Right Hand Decimal Point
  ±1. Overflow Character
- **Categorized for Luminous Intensity**
  Yellow and Green Categorized for Color
  Use of Like Categories Yields a Uniform Display
- **High Light Output**
- **High Peak Current**
- **Excellent for Long Digit String Multiplexing**
- **Intensity and Color Selection Option**
  See Intensity and Color Selected Displays Data Sheet
- **Sunlight Viewable AlGaAs**

Description

The 14.2 mm (0.56 inch) LED seven segment displays are designed for viewing distances up to 7 metres (23 feet). These devices use and industry standard size package and pinout. Both the numeric and ±1 overflow devices feature a right hand decimal point. All devices are available as either common anode or common cathode.



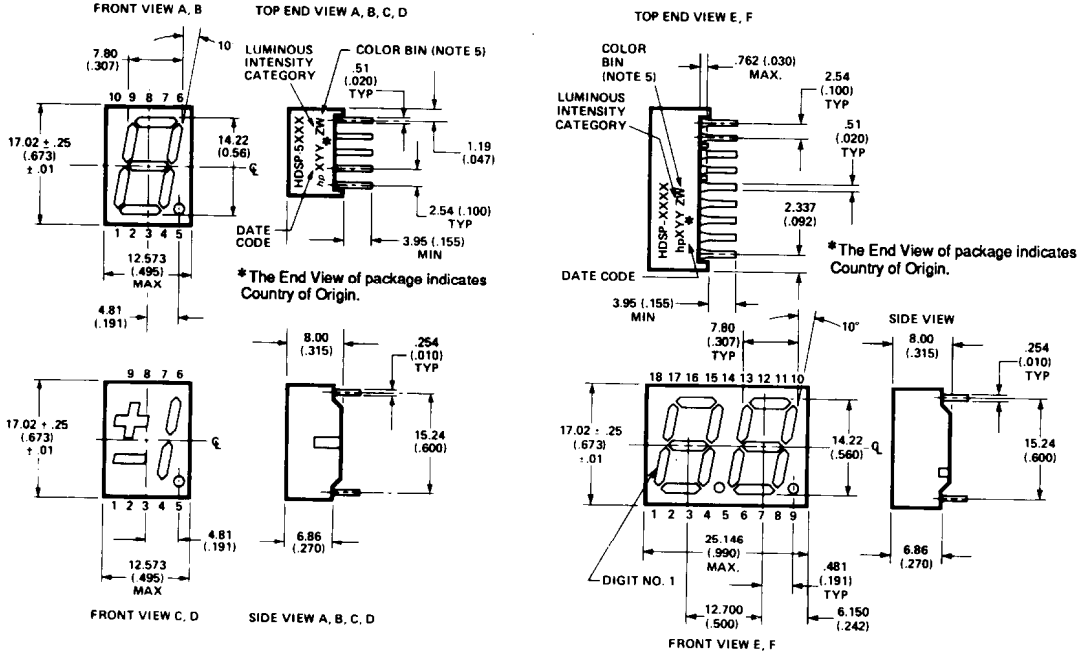
Devices

Red HDSP-	AlGaAs Red HDSP-[1]	HER HDSP-[1]	Yellow HDSP-	Green HDSP-	Description	Package Drawing
5301	H151	5501	5701	5601	Common Anode Right Hand Decimal	A
5303	H153	5503	5703	5603	Common Cathode Right Hand Decimal	B
5307	H157	5507	5707	5607	Common Anode ±1. Overflow	C
5308	H158	5508	5708	5608	Common Cathode ±1. Overflow	D
5321		5521	5721	5621	Two Digit Common Anode Right Hand Decimal	E
5323		5523	5723	5623	Two Digit Common Cathode Right Hand Decimal	F

Note:
1. These displays are recommended for high ambient light operation. Please refer to the HDSP-H10X/K12X AlGaAs and HDSP-555X HER data sheet for low current operation.

These displays are ideal for most applications. Pin for pin equivalent displays are also available in a low current design. The low current displays are ideal for portable applications. For additional information see the Low Current Seven Segment Displays data sheet.

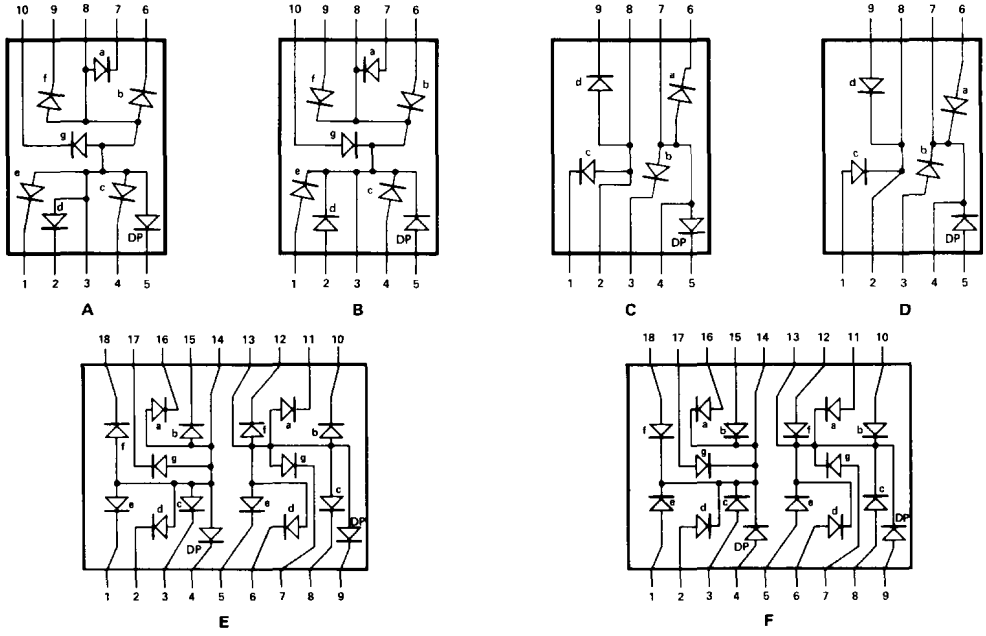
Package Dimensions



PIN	FUNCTION					
	A	B	C	D	E	F
1	CATHODE e	ANODE e	CATHODE c	ANODE c	E CATHODE NO. 1	E ANODE NO. 1
2	CATHODE d	ANODE d	ANODE c, d	CATHODE c, d	D CATHODE NO. 1	D ANODE NO. 1
3	ANODE[3]	CATHODE[3]	CATHODE b	ANODE b	C CATHODE NO. 1	C ANODE NO. 1
4	CATHODE c	ANODE c	ANODE a, b, DP	CATHODE a, b, DP	DP CATHODE NO. 1	DP ANODE NO. 1
5	CATHODE DP	ANODE DP	CATHOPDE DP	ANODE DE	E CATHODE NO. 1	E ANODE NO. 2
6	CATHODE b	ANODE b	CATHODE a	ANODE a	D CATHODE NO. 2	D ANODE NO. 2
7	CATHODE a	ANODE a	ANODE a, b, DP	CATHODE a, b, DP	G CATHODE NO. 2	G ANODE NO. 2
8	ANODE[3]	CATHODE[3]	ANODE c, d	CATHODE c, d	C CATHODE NO. 2	C ANODE NO. 2
9	CATHODE f	ANODE f	CATHODE d	ANODE d	DP CATHODE NO. 2	DP ANODE NO. 2
10	CATHODE g	ANODE g	NO PIN	NO PIN	B CATHODE NO. 2	B ANODE NO. 2
11					A CATHODE NO. 2	A ANODE NO. 2
12					F CATHODE NO. 2	F ANODE NO. 2
13					DIGIT NO. 2 ANODE	DIGIT NO. 2 CATHODE
14					DIGIT NO. 1 ANODE	DIGIT NO. 2 CATHODE
15					B CATHODE NO. 1	B ANODE NO. 1
16					A CATHODE NO. 1	A ANODE NO. 1
17					G CATHODE NO. 1	G ANODE NO. 1
18					F CATHODE NO. 1	F ANODE NO. 1

NOTES:
1. ALL DIMENSIONS IN MILLIMETRES (INCHES).
2. ALL UNTOLERANCED DIMENSIONS ARE FOR REFERENCE ONLY.
3. REDUNDANT ANODES.
4. REDUNDANT CATHODES.
5. FOR HDSP-5600/-5700 SERIES PRODUCT ONLY.

Internal Circuit Diagram



Absolute Maximum Ratings

Description	Red HDSP-5300 Series	AlGaAs Red HDSP-H150 Series	HER HDSP-5500 Series	Yellow HDSP-5700 Series	Green HDSP-5600 Series	Units
Average Power per Segment or DP	82	96	105	80	105	mW
Peak Forward Current per Segment or DP	150[1]	160[3]	90[5]	60[7]	90[9]	mA
DC Forward Current per Segment or DP	25[2]	40[4]	30[6]	20[8]	30[10]	mA
Operating Temperature Range	-40 to +100	-20 to +100[11]	-40 to +100			°C
Storage Temperature Range	-55 to +100					°C
Reverse Voltage per Segment or DP	3.0					V
Lead Solder Temperature for 3 Seconds (1.60 mm [0.063 in.] below seating plane)	260					°C

Notes:

1. See Figure 1 to establish pulsed conditions.
2. Derate above 80°C at 0.63 mA/°C.
3. See Figure 2 to establish pulsed conditions.
4. Derate above 46°C at 0.54 mA/°C.
5. See Figure 7 to establish pulsed conditions.
6. Derate above 53°C at 0.45 mA/°C.
7. See Figure 8 to establish pulsed conditions.
8. Derate above 81°C at 0.52 mA/°C.
9. See Figure 9 to establish pulsed conditions.
10. Derate above 39°C at 0.37 mA/°C.
11. For operation below -20°C, contact your local HP components sales office or an authorized distributor.

Electrical/Optical Characteristics at T_A = 25°C

Red

Device Series HDSP-	Parameter	Symbol	Min.	Typ.	Max.	Units	Test Conditions
53XX	Luminous Intensity/Segment[1,2] (Digit Average)	I_V	600	1300		µcd	I_F = 20 mA
				1400			I_F = 100 mA Peak: 1 of 5 df
	Forward Voltage/Segment or DP	V_F		1.6	2.0	V	I_F = 20 mA
	Peak Wavelength	λ_{PEAK}		655		nm	
	Dominant Wavelength[3]	λ_d		640		nm	
	Reverse Voltage/Segment or DP[4]	V_R	3.0	12		V	I_R = 100 µA
	Temperature Coefficient of V_F/Segment or DP	ΔV_F/°C		-2		mV/°C	
	Thermal Resistance LED Junction-to-Pin	$R\theta_{J\text{-}Pin}$		345		°C/W/ Seg	

AlGaAs Red

Device Series HDSP-	Parameter	Symbol	Min.	Typ.	Max.	Units	Test Conditions
H15X	Luminous Intensity/Segment[1,2,5] (Digit Average)	I_V	9.1	16.0		mcd	I_F = 20 mA
	Forward Voltage/Segment or DP	V_F		1.8		V	I_F = 20 mA
				2.0	3.0		I_F = 100 mA
	Peak Wavelength	λ_{PEAK}		645		nm	
	Dominant Wavelength[3]	λ_d		637		nm	
	Reverse Voltage/Segment or DP[4]	V_R	3.0	15		V	I_R = 100 µA
	Temperature Coefficient of V_F/Segment or DP	ΔV_F/°C		-2		mV/°C	
	Thermal Resistance LED Junction-to-Pin	$R\theta_{J\text{-}Pin}$		400		°C/W/ Seg	

High Efficiency Red

Device Series HDSP-	Parameter	Symbol	Min.	Typ.	Max.	Units	Test Conditions
55XX	Luminous Intensity/Segment[1,2,6] (Digit Average)	I_V	900	2800		µcd	I_F = 10 mA
				3700			I_F = 60 mA Peak: 1 of 6 df
	Forward Voltage/Segment or DP	V_F		2.1	2.5	V	I_F = 20 mA
	Peak Wavelength	λ_{PEAK}		635		nm	
	Dominant Wavelength[3]	λ_d		626		nm	
	Reverse Voltage/Segment or DP[4]	V_R	3.0	30		V	I_R = 100 µA
	Temperature Coefficient of V_F/Segment or DP	ΔV_F/°C		-2		mV/°C	
	Thermal Resistance LED Junction-to-Pin	$R\theta_{J\text{-}Pin}$		345		°C/W/	

Yellow

Device Series HDSP-	Parameter	Symbol	Min.	Typ.	Max.	Units	Test Conditions
57XX	Luminous Intensity/Segment[1,2] (Digit Average)	I_V	600	1800		µcd	I_F = 10 mA
				2750			I_F = 60 mA Peak: 1 of 6 df
	Forward Voltage/Segment or DP	V_F		2.1	2.5	V	I_F = 20 mA
	Peak Wavelength	λ_{PEAK}		583		nm	
	Dominant Wavelength[3,7]	λ_d	581.5	586	592.5	nm	
	Reverse Voltage/Segment or DP[4]	V_R	3.0	40		V	I_R = 100 µA
	Temperature Coefficient of V_F/Segment or DP	ΔV_F/°C		-2		mV/°C	
	Thermal Resistance LED Junction-to-Pin	$R\theta_{J\text{-}Pin}$		345		°C/W/ Seg	

High Performance Green

Device Series HDSP-	Parameter	Symbol	Min.	Typ.	Max.	Units	Test Conditions
56XX	Luminous Intensity/Segment[1,2] (Digit Average)*	I_V	900	2500		µcd	I_F = 10 mA
				3100			I_F = 60 mA Peak: 1 of 6 df
	Forward Voltage/Segment or DP	V_F		2.1	2.5	V	I_F = 10 mA
	Peak Wavelength	λ_{PEAK}		566		nm	
	Dominant Wavelength[3,7]	λ_d		571	577	nm	
	Reverse Voltage/Segment or DP[4]	V_R	3.0	50		V	I_R = 100 µA
	Temperature Coefficient of V_F/Segment or DP	ΔV_F/°C		-2		mV/°C	
	Thermal Resistance LED Junction-to-Pin	$R\theta_{J\text{-}Pin}$		345		°C/W/ Seg	

Notes:
1. Device case temperature is 25°C prior to the intensity measurement.
2. The digits are categorized for luminous intensity. The intensity category is designated by a letter on the side of the package.
3. The dominant wavelength, λ_d, is derived from the CIE chromaticity diagram and is that single wavelength which defines the color of the device.
4. Typical specification for reference only. Do not exceed absolute maximum ratings.
5. For low current operation, the AlGaAs HDSP-H10X series displays are recommended. They are tested at 1 mA dc/segment and are pin for pin compatible with the HDSP-H15X series.
6. For low current operation, the HER HDSP-555X series displays are recommended. They are tested at 2 mA dc/segment and are pin for pin compatible with the HDSP-550X series.
7. The Yellow (HDSP-5700) and Green (HDSP-5600) displays are categorized for dominant wavelength. The category is designated by a number adjacent to the luminous intensity category letter.

Red, AlGaAs Red

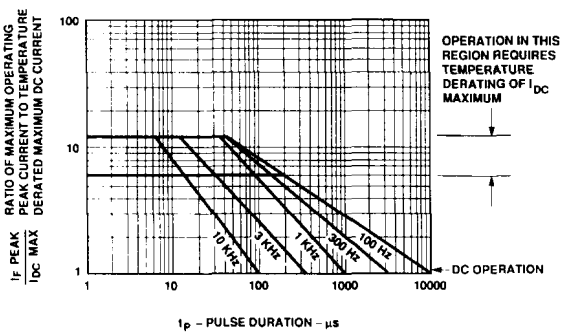


Figure 1. Maximum Tolerable Peak Current vs. Pulse Duration – Red.

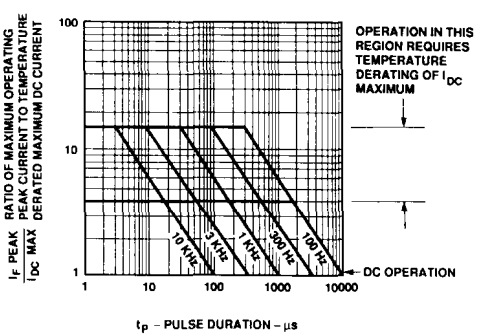


Figure 2. Maximum Tolerable Peak Current vs. Pulse Duration – AlGaAs Red.

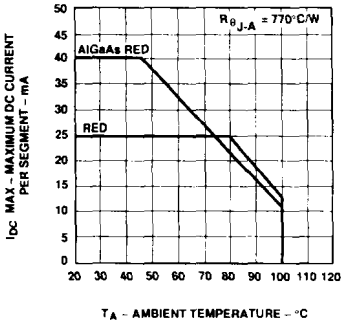


Figure 3. Maximum Allowable DC Current vs. Ambient Temperature.

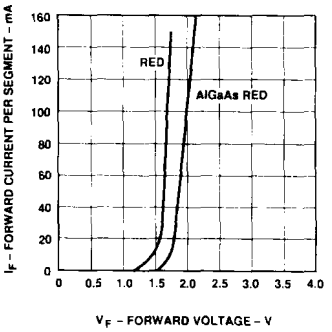


Figure 4. Forward Current vs. Forward Voltage.

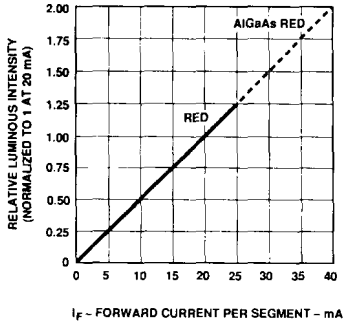


Figure 5. Relative Luminous Intensity vs. DC Forward Current.

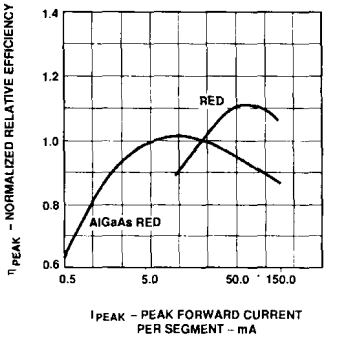


Figure 6. Relative Efficiency (Luminous Intensity per Unit Current) vs. Peak Current.

HER, Yellow, Green

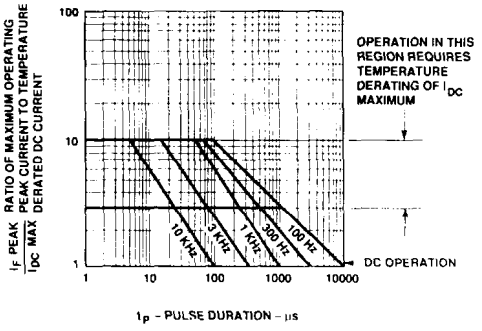


Figure 7. Maximum Tolerable Peak Current vs. Pulse Duration - HER.

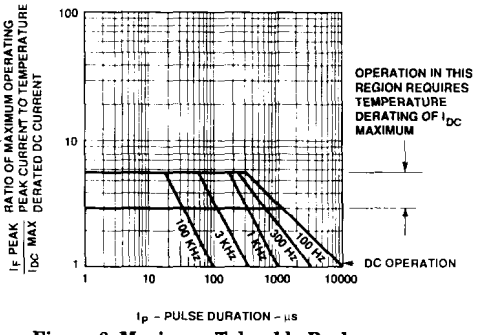


Figure 8. Maximum Tolerable Peak Current vs. Pulse Duration - Yellow.

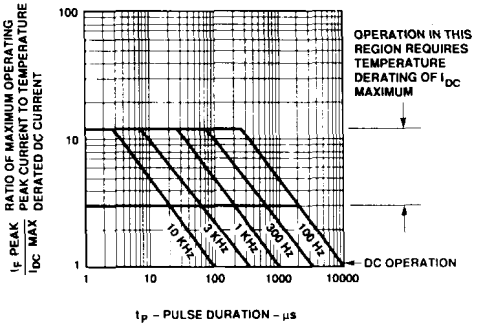


Figure 9. Maximum Tolerable Peak Current vs. Pulse Duration - Green.

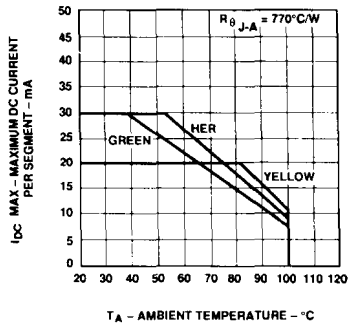


Figure 10. Maximum Allowable DC Current vs. Ambient Temperature.

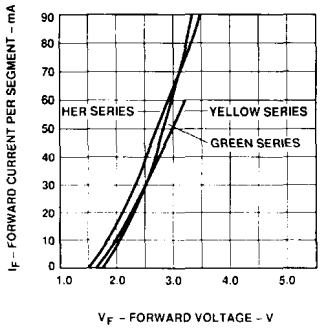


Figure 11. Forward Current vs. Forward Voltage.

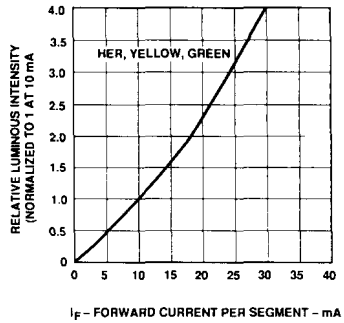


Figure 12. Relative Luminous Intensity vs. DC Forward Current.

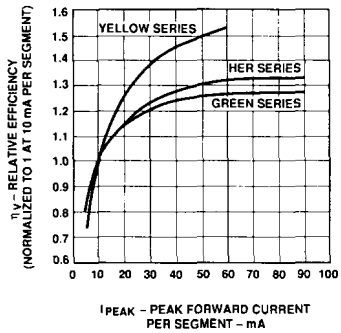


Figure 13. Relative Efficiency (Luminous Intensity per Unit Current) vs. Peak Current.

Electrical/Optical

For more information on electrical/optical characteristics, please see Application Note 1005.

Contrast Enhancement

For information on contrast enhancement please see Application Note 1015.

Soldering/Cleaning

Cleaning agents from the ketone family (acetone, methyl ethyl ketone, etc.) and from the chlorinated hydrocarbon family (methylene chloride, trichloro–ethylene, carbon tetrachloride, etc.) are not recommended for cleaning LED parts. All of these various solvents attack or dissolve the encapsulating epoxies used to form the package of plastic LED parts.

For information on soldering LEDs please refer to Application Note 1027.